

- 1 -

File No. 14836-9US AD/JG/bns

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**UNITED STATES PATENT AND TRADEMARK OFFICE**

Application No : 10/532,627  
Filing Date : April 25, 2005  
Applicant : Microbridge Technologies Inc.  
Inventor : Leslie M. Landsberger et al.  
Title of Invention : METHOD FOR PRODUCING A PACKAGED INTEGRATED  
CIRCUIT  
Classification : 2822  
Examiner : David E. Graybill Tel: (571) 272-1930  
Patent Agent : Alexandra Daoud Tel: (514) 847-4333

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**Mail Stop Amendment**  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450  
USA

**RESPONSE**

Sir:

In response to the Office Action dated June 27, 2007 in connection with the above-identified Application, please consider the following:

Remarks begin on page 2 of this paper